Dual General Purpose Transistor

The NST3906DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FF}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- This is a Pb-Free Device

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector - Emitter Voltage		V_{CEO}	-40	V
Collector - Base Voltage		V_{CBO}	-40	V
Emitter - Base Voltage		V _{EBO}	-5.0	V
Collector Current - Continuous		I _C	-200	mA
Electrostatic Discharge	HBM MM	ESD Class	2 B	

THERMAL CHARACTERISTICS

Characteristic (Single Heated)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1)	P _D	240 1.9	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	520	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	280 2.2	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	446	°C/W
Characteristic (Dual Heated) (Note 3)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1)	P _D	350 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	357	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	420 3.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	297	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 @ 100 mm², 1 oz. copper traces, still air.

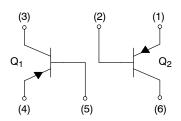
2. FR-4 @ 500 mm², 1 oz. copper traces, still air.

- 3. Dual heated values assume total power is sum of two equally powered channels.



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NST3906DP6T5G



SOT-963 CASE 527AD

MARKING DIAGRAM



= Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NST3906DP6T5G	SOT-963 (Pb-Free)	8000/Tape & Reel

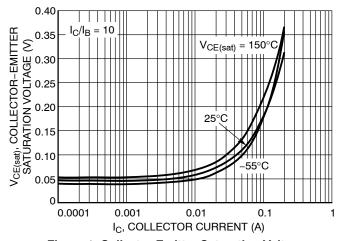
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTER	ISTICS	1	•	1	1
Collector – Emitter Breakdown Voltage (Note 4) (I _C = 1.0 mAdc, I _B = 0)		V _{(BR)CEO}	-40	_	V
Collector - Base Brea	akdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	-40	_	V
Emitter – Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)		V _{(BR)EBO}	-5.0	_	V
Collector Cutoff Current (V _{CE} = 30 Vdc, V _{EB} = 3.0 Vdc)		or Cutoff Current (V _{CE} = 30 Vdc, V _{EB} = 3.0 Vdc) I _{CEX}		-50	nA
ON CHARACTERIS	STICS (Note 4)				•
DC Current Gain $ \begin{aligned} &(I_C = -0.1 \text{ mA, V}_{CE} \\ &(I_C = -1.0 \text{ mA, V}_{CE} \\ &(I_C = -10 \text{ mA, V}_{CE} \\ &(I_C = -50 \text{ mA, V}_{CE} \\ &(I_C = -100 \text{ mA, V}_{CE} \end{aligned} $	= -1.0 V) = -1.0 V) = -1.0 V)	h _{FE}	60 80 100 60 30	- 300 - -	-
Collector – Emitter Saturation Voltage ($I_C = -10 \text{ mA}$, $I_B = -1.0 \text{ mA}$) ($I_C = -50 \text{ mA}$, $I_B = -5.0 \text{ mA}$)		V _{CE(sat)}	_ _	-0.25 -0.4	V
Base – Emitter Saturation Voltage (I_C = -10 mA, I_B = -1.0 mA) (I_C = -50 mA, I_B = -5.0 mA)		V _{BE(sat)}	-0.65 -	-0.85 -0.95	V
SMALL-SIGNAL C	CHARACTERISTICS				
Current – Gain – Bandwidth Product (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)		f _T	250	_	MHz
Output Capacitance (V _{CB} = -5.0 V, I _E = 0 mA, f = 1.0 MHz)		C _{obo}	-	4.5	pF
Input Capacitance (V _{EB} = -0.5 V, I _E = 0 mA, f = 1.0 MHz)		C _{ibo}	-	10.0	pF
Noise Figure (V _{CE} = -5.0 V, I _C = -100 μ A, R _S = 1.0 k Ω , f = 1.0 kHz)		NF	-	4.0	dB
SWITCHING CHAP	RACTERISTICS				
Delay Time	$(V_{CC} = -3.0 \text{ V}, V_{BE} = 0.5 \text{ V})$	t _d	-	35	
Rise Time	$(I_C = -10 \text{ mA}, I_{B1} = -1.0 \text{ mA})$	t _r	-	35	ns
Storage Time	$(V_{CC} = -3.0 \text{ V}, I_C = -10 \text{ mA})$	t _s	-	250	

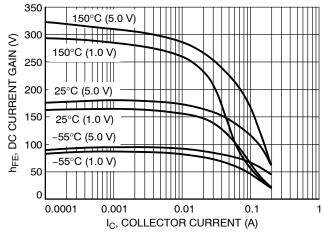
^{4.} Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle ≤ 2.0%.

Fall Time



 $(I_{B1} = I_{B2} = -1.0 \text{ mA})$

Figure 1. Collector Emitter Saturation Voltage vs. Collector Current



 t_f

ns

50

Figure 2. DC Current Gain vs. Collector Current

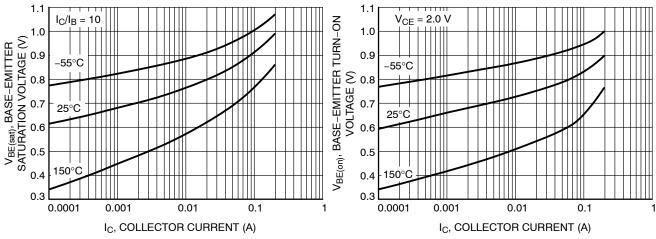


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Turn-On Voltage vs.
Collector Current

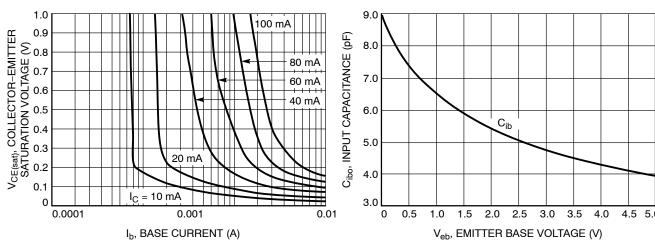


Figure 5. Saturation Region

Figure 6. Input Capacitance

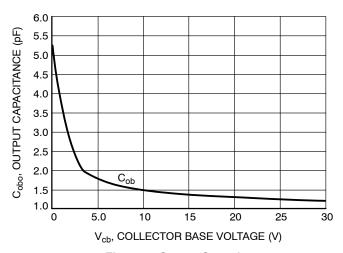
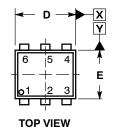
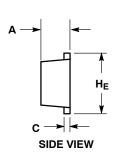


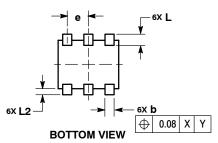
Figure 7. Output Capacitance

PACKAGE DIMENSIONS

SOT-963 CASE 527AD **ISSUE E**





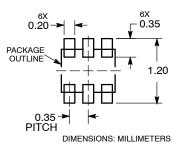


NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.34	0.37	0.40	
b	0.10	0.15	0.20	
С	0.07	0.12	0.17	
D	0.95	1.00	1.05	
E	0.75	0.80	0.85	
е	0.35 BSC			
Hε	0.95	1.00	1.05	
L	0.19 REF			
L2	0.05	0.10	0.15	

RECOMMENDED MOUNTING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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